

September 1983 Revised February 1999

MM74HCU04 Hex Inverter

General Description

The MM74HCU04 inverters utilize advanced silicon-gate CMOS technology to achieve operating speeds similar to LS-TTL gates with the low power consumption of standard CMOS integrated circuits.

The MM74HCU04 is an unbuffered inverter. It has high noise immunity and the ability to drive 15 LS-TTL loads. The 74HCU logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs

are protected from damage due to static discharge by internal diode clamps to $V_{\mbox{\scriptsize CC}}$ and ground.

Features

- Typical propagation delay: 7 ns
- Fanout of 15 LS-TTL loads
- Quiescent power consumption: 10 µA maximum at room temperature
- Low input current: 1 µA maximum

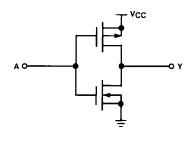
Ordering Code:

| Order Number | Package Number | Package Description |
|--------------|----------------|--|
| MM74HCU04M | M14A | 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow |
| MM74HCU04SJ | M14D | 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| MM74HCU04MTC | MTC14 | 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |
| MM74HCU04N | N14A | 14-Lead Plastic Dual-In-Lead Package (PDIP), JEDEC MS-001, 0.300" Wide |

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Schematic Diagram



Absolute Maximum Ratings(Note 1)

(Note 2)

Power Dissipation (P_D)

 (Note 3)
 600 mW

 S.O. Package only
 500 mW

Lead Temperature (T_L)

(Soldering 10 seconds)

Recommended Operating Conditions

| | Min | Max | Units |
|---|-----|----------|-------|
| Supply Voltage (V _{CC}) | 2 | 6 | V |
| DC Input or Output Voltage | 0 | V_{CC} | V |
| (V_{IN}, V_{OUT}) | | | |
| Operating Temperature Range (T _A) | -40 | +85 | °C |

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -

12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

| Symbol | Parameter | Conditions | V _{CC} | T _A = 25°C | | $T_A = -40 \text{ to } 85^{\circ}\text{C}$ $T_A = -55 \text{ to } 125^{\circ}\text{C}$ | | Units |
|-----------------|--------------------|--|-----------------|-----------------------|------|--|-------|-------|
| Syllibol | | | *CC | Тур | | Guaranteed L | Units | |
| V _{IH} | Minimum HIGH Level | | 2.0V | | 1.7 | 1.7 | 1.7 | V |
| | Input Voltage | | 4.5V | | 3.6 | 3.6 | 3.6 | V |
| | | | 6.0V | | 4.8 | 4.8 | 4.8 | V |
| V _{IL} | Maximum LOW Level | | 2.0V | | 0.3 | 0.3 | 0.3 | V |
| | Input Voltage | | 4.5V | | 0.8 | 0.8 | 0.8 | V |
| | | | 6.0V | | 1.1 | 1.1 | 1.1 | V |
| V _{OH} | Minimum HIGH Level | $V_{IN} = V_{IL}$ | | | | | | |
| | Output Voltage | $ I_{OUT} \le 20 \ \mu A$ | 2.0V | 2.0 | 1.8 | 1.8 | 1.8 | V |
| | | | 4.5V | 4.5 | 4.0 | 4.0 | 4.0 | V |
| | | | 6.0V | 6.0 | 5.5 | 5.5 | 5.5 | V |
| | | V _{IN} = GND | | | | | | |
| | | $ I_{OUT} \le 4.0 \text{ mA}$ | 4.5V | 4.2 | 3.98 | 3.84 | 3.7 | V |
| | | $ I_{OUT} \le 5.2 \text{ mA}$ | 6.0V | 5.7 | 5.48 | 5.34 | 5.2 | V |
| V _{OL} | Maximum LOW Level | $V_{IN} = V_{IH}$ | | | | | | |
| | Output Voltage | $ I_{OUT} \le 20 \ \mu A$ | 2.0V | 0 | 0.2 | 0.2 | 0.2 | V |
| | | | 4.5V | 0 | 0.5 | 0.5 | 0.5 | V |
| | | | 6.0V | 0 | 0.5 | 0.5 | 0.5 | V |
| | | $V_{IN} = V_{CC}$ | | | | | | |
| | | $ I_{OUT} \le 6.0 \text{ mA}$ | 4.5V | 0.2 | 0.26 | 0.33 | 0.4 | V |
| | | $ I_{OUT} \le 7.8 \text{ mA}$ | 6.0V | 0.2 | 0.26 | 0.33 | 0.4 | V |
| I _{IN} | Maximum Input | V _{IN} = V _{CC} or GND | 6.0V | | ±0.1 | ±1.0 | ±1.0 | μΑ |
| | Current | | | | | | | |
| I _{CC} | Maximum Quiescent | V _{IN} = V _{CC} or GND | 6.0V | | 2.0 | 20 | 40 | μΑ |
| | Supply Current | $I_{OUT} = 0 \mu A$ | | | | | | |
| | | | | | | | | |

260°C

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

| Symbol | Parameter | Conditions | Тур | Guaranteed Limit | Units |
|-------------------------------------|---------------------|------------|-----|---------------------|-------|
| t _{PHL} , t _{PLH} | Maximum Propagation | | 7 | 13 | ns |
| | Delay | | | | |

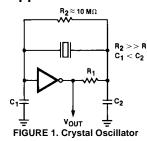
AC Electrical Characteristics

 $V_{CC} = 2.0 \text{V}$ to 6.0V, $C_L = 50 \text{ pF}$, $t_r = t_f = 6 \text{ ns}$ (unless otherwise specified)

| Symbol | Parameter | Conditions | v _{cc} | T _A =25°C | | T _A =-40 to 85°C | T _A =-55 to 125°C | Units |
|-------------------------------------|----------------------|------------|-----------------|-----------------------|----|-----------------------------|------------------------------|-------|
| | Farameter | | | Typ Guaranteed Limits | | | Ullits | |
| t _{PHL} , t _{PLH} | Maximum Propagation | | 2.0V | 49 | 82 | 103 | 120 | ns |
| | Delay | | 4.5V | 9.9 | 16 | 21 | 24 | ns |
| | | | 6.0V | 8.4 | 14 | 18 | 20 | ns |
| t _{TLH} , t _{THL} | Maximum Output Rise | | 2.0V | 30 | 75 | 95 | 110 | ns |
| | and Fall Time | | 4.5V | 8 | 15 | 19 | 22 | ns |
| | | | 6.0V | 7 | 13 | 16 | 19 | ns |
| C _{PD} | Power Dissipation | (per gate) | | 90 | | | | pF |
| | Capacitance (Note 5) | | | | | | | |
| C _{IN} | Maximum Input | | | 8 | 15 | 15 | 15 | pF |
| | Capacitance | | | | | | | |

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

Typical Applications



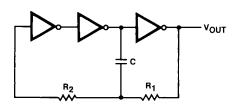
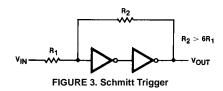
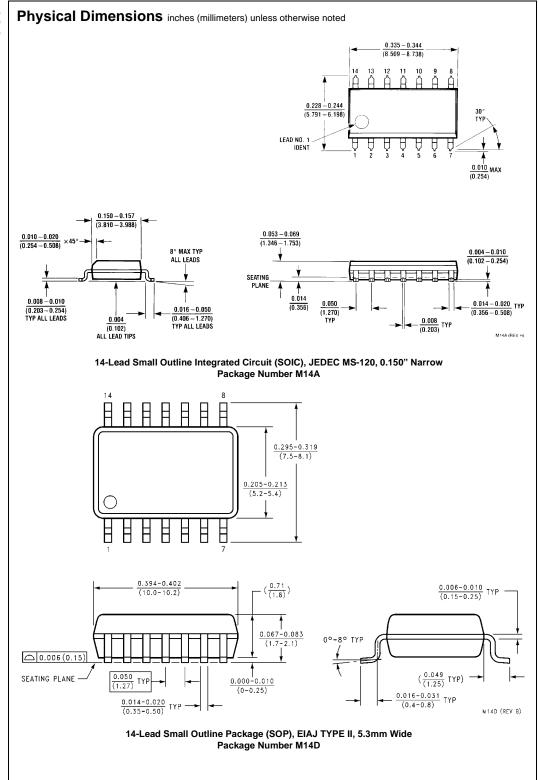


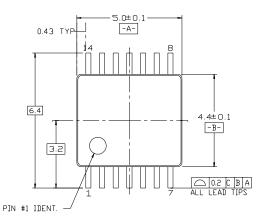
FIGURE 2. Stable RC Oscillator

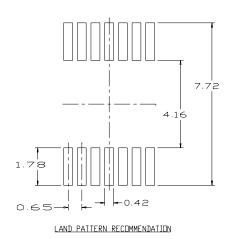


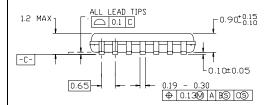


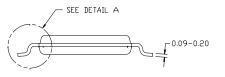
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE



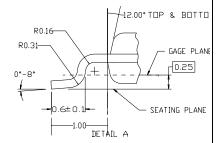






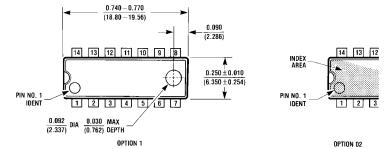
NOTES

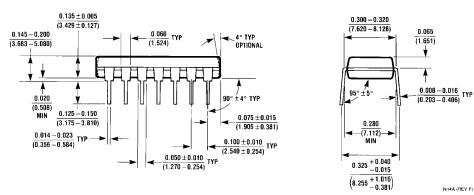
- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION ABJREF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com